

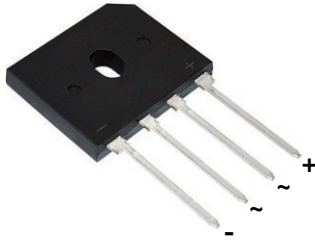


# THE DATASHEET OF GBU8M-E3/51

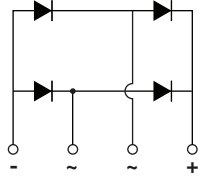




## Glass Passivated Single-Phase Bridge Rectifier



Case Style GBU



Case Style GBU

### FEATURES

- UL recognition file number E54214
- Ideal for printed circuit boards
- High surge current capability
- High case dielectric strength of 1500 V<sub>RMS</sub>
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### LINKS TO ADDITIONAL RESOURCES



3D Models

### TYPICAL APPLICATIONS

General purpose use in AC/DC bridge full wave rectification for monitor, TV, printer, power supply, switching mode power supply, adapter, audio equipment, and home appliances applications.

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	8.0 A
$V_{RRM}$	50 V, 100 V, 200 V, 400 V, 600 V, 800 V, 1000 V
$I_{FSM}$	200 A
$I_R$	5 $\mu$ A
$V_F$ at $I_F = 8.0$ A	1.0 V
$T_J$ max.	150 °C
Package	GBU
Circuit configuration	In-line

### MECHANICAL DATA

#### Case: GBU

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 and M3 suffix meet JESD 201 class 1A whisker test

**Polarity:** as marked on body

**Mounting Torque:** 10 cm·kg (8.8 inches·lbs) max.

**Recommended Torque:** 5.7 cm·kg (5 inches·lbs)

MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)									
PARAMETER	SYMBOL	GBU8A	GBU8B	GBU8D	GBU8G	GBU8J	GBU8K	GBU8M	UNIT
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum average forward rectified output current at	$T_C = 60$ °C	$I_{F(AV)}^{(1)}$							A
	$T_A = 40$ °C	$I_{F(AV)}^{(2)}$							
Peak forward surge current single sine-wave super-imposed on rated load	$I_{FSM}$	200							A
Rating for fusing ( $t < 8.3$ ms)	$I^2t$	166							A <sup>2</sup> s
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to +150							°C

### Notes

(1) Unit case mounted on aluminum plate heatsink

(2) Units mounted on PCB with 0.5" x 0.5" (12 mm x 12 mm) copper pads and 0.375" (9.5 mm) lead length



<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)										
PARAMETER	TEST CONDITIONS	SYMBOL	GBU8A	GBU8B	GBU8D	GBU8G	GBU8J	GBU8K	GBU8M	UNIT
Maximum instantaneous forward voltage drop per diode	8.0 A	$V_F$				1.0				V
Maximum DC reverse current at rated DC blocking voltage per diode	$T_A = 25\text{ }^\circ\text{C}$	$I_R$				5.0				$\mu\text{A}$
	$T_A = 125\text{ }^\circ\text{C}$					500				
Typical junction capacitance per diode	4 V, 1 MHz	$C_J$				68				pF

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)										
PARAMETER	SYMBOL	GBU8A	GBU8B	GBU8D	GBU8G	GBU8J	GBU8K	GBU8M	UNIT	
Typical thermal resistance	$R_{\theta JA}^{(2)}$				20				$^\circ\text{C/W}$	
	$R_{\theta JC}^{(1)(3)}$				4.0					

**Notes**

- (1) Units case mounted on aluminum plate heatsink
- (2) Units mounted in free air, no heatsink on PCB, 0.5" x 0.5" (12 mm x 12 mm) copper pads, 0.375" (9.5 mm) lead length
- (3) Recommended mounting position is to bolt down on heatsink with silicone thermal compound for maximum heat transfer with #6 screws

<b>ORDERING INFORMATION</b>				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
GBU8J-E3/45	3.857	45	20	Tube
GBU8J-E3/51	3.857	51	250	Paper tray
GBU8J-M3/45	3.857	45	20	Tube
GBU8J-M3/51	3.857	51	250	Paper tray

**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)

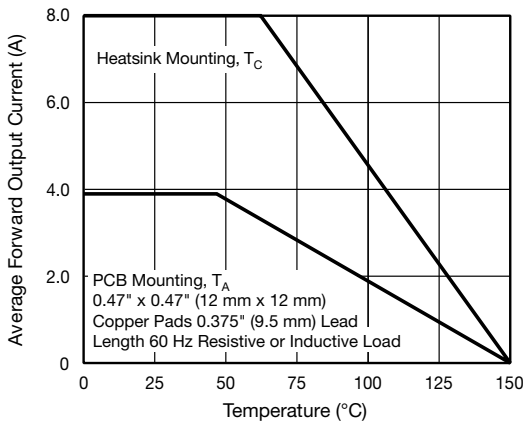


Fig. 1 - Derating Curve Output Rectified Current

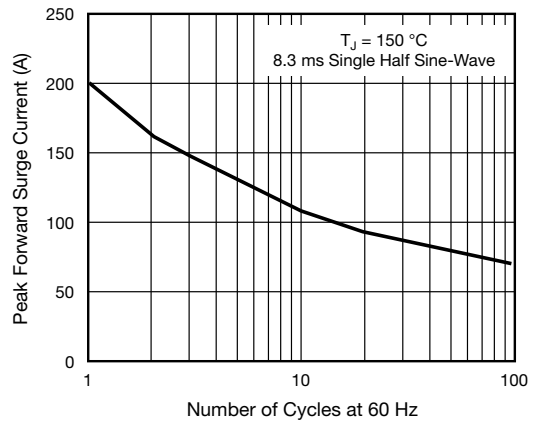


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current Per Diode

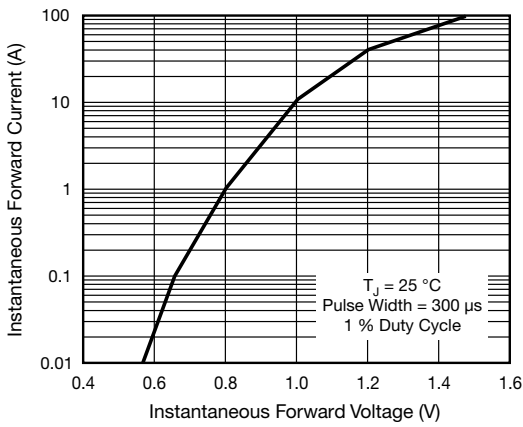


Fig. 3 - Typical Forward Characteristics Per Diode

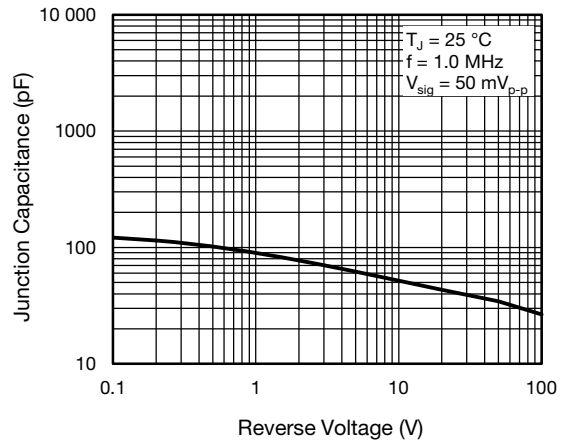


Fig. 5 - Typical Junction Capacitance Per Diode

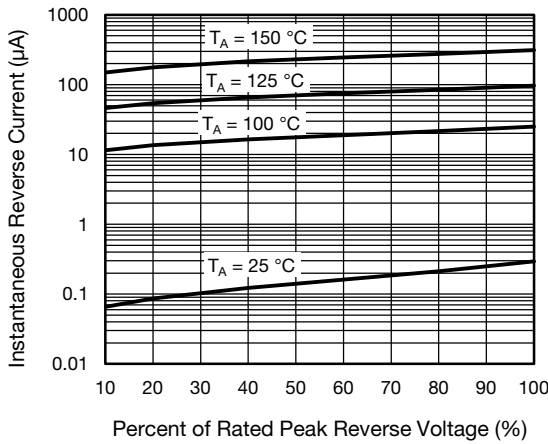


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

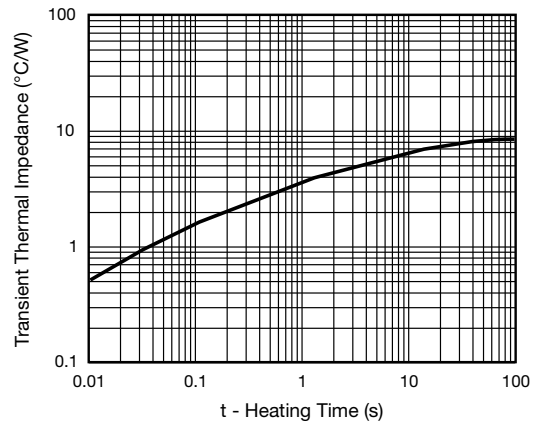
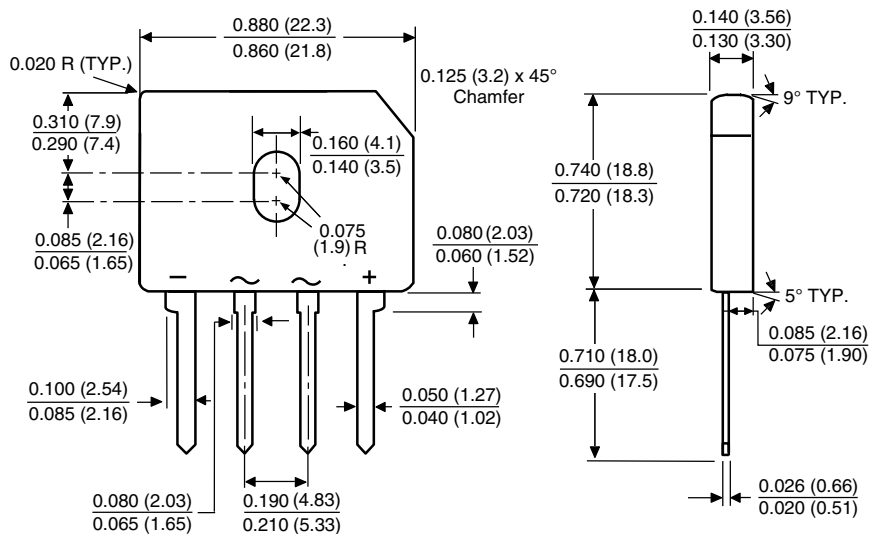


Fig. 6 - Typical Transient Thermal Impedance Per Diode

**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

**Case Type GBU**



Polarity shown on front side of case, positive lead by beveled corner



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